

LS3N190 P-CHANNEL MOSFET



The LS3N190 is a monolithic dual enhancement mode P-Channel Mosfet

The LS3N190 is a dual enhancement mode P-Channel Mosfet and is ideal for space constrained applications and those requiring tight electrical matching.

The hermetically sealed TO-78 package is well suited for high reliability and harsh environment applications.

(See Packaging Information).

LS3N190 Features:

- Very high Input Impedance
- High Gate Breakdown Voltage
- Low Capacitance

FEATURES						
DIRECT REPLACEMENT FOR INTERSIL LS3N190						
LOW GATE LEAKAGE CURRENT	I _{GSS} ≤± 10pA					
LOW TRANSFER CAPACITANCE	C _{rss} ≤ 1.0pF					
ABSOLUTE MAXIMUM RATINGS ¹ @ 25°C (unless otherwise noted)						
Maximum Temperatures						
Storage Temperature	-65°C to +150°C					
Operating Junction Temperature	-55°C to +135°C					
Maximum Power Dissipation						
Continuous Power Dissipation (one side)	300mW					
Continuous Power Dissipation (one side)	525mW					
MAXIMUM CURRENT						
Drain to Source ²	50mA					
MAXIMUM VOLTAGES						
Drain to Gate or Drain to Source ²	-30V					
Transient Gate to Source ^{2,3}	±125V					
Gate-Gate Voltage	±80V					

LS3N190 ELECTRICAL CHARACTERISTICS @ 25°C (unless otherwise noted)

	MICAL CHAMACTEMISTICS @ 25 C famile					
SYMBOL	CHARACTERISTIC	MIN	TYP.	MAX	UNITS	CONDITIONS
BV_{DSS}	Drain to Source Breakdown Voltage	-40				I _D = -10μA
BV_{SDS}	Source to Drain Breakdown Voltage	-40				$I_S = -10 \mu A$, $V_{BD} = 0 V$
V_{GS}	Gate to Source Voltage	-3.0		-6.5	V	$V_{DS} = -15V$, $I_{D} = -500\mu A$
$V_{GS(th)}$	Gate to Source Threshold Voltage	-2.0		-5.0		$V_{DS} = -15V$, $I_{D} = -500\mu A$
		-2.0		-5.0		$V_{DS} = V_{GS}$, $I_D = -10\mu A$
I _{GSSR}	Gate Reverse Leakage Current			10		V _{GS} = 40V
I_{GSSF}	Forward Gate Leakage Current			-10		V _{GS} = -40V
I_{DSS}	Drain to Source Leakage Current			-200	pA	V _{DS} = -15V
I _{SDS}	Source to Drain Leakage Current			-400		$V_{SD} = -15V \ V_{DB} = 0$
I _{D(on)}	Drai <mark>n</mark> Current "On"	-5.0		-30	mA	$V_{DS} = -15V, V_{GS} = -10V$
r _{DS(on)}	Drain to Source "On" Resistance			300	Ω	$V_{DS} = -20V$, $I_{D} = -100 \mu A$
g _{fs}	Forward <mark>Tr</mark> ansc <mark>o</mark> nductance ⁴	1500		4000	μS	$V_{DS} = -15V$, $I_{D} = -5mA$, $f = 1kHz$
Y _{os}	Output Admittance			300		J CL Y
C _{iss}	Input Capacitance			4.5		
C_{rss}	Reverse Transfer Capacitance			1.0	pF	$V_{DS} = -15V$, $I_{D} = -5mA$, $f = 1MHz$
C _{oss}	Output Capacitance			3.0		

MATCHING CHARACTERISTICS LS3N190

SYMBOL		LIMITS			
CHARACTERISTIC		MIN	MAX	UNITS	CONDITIONS
g_{fs1}/g_{fs2}	Forward Transconductance Ratio	0.85	1.0	ns	$V_{DS} = -15V$, $I_{D} = -500\mu A$, $f = kHz$
V _{GS1-2}	Gate Source Threshold Voltage Differential ⁵		100	mV	$V_{DS} = -15V$, $I_D = -500\mu A$
$\Delta V_{GS1-2}/\Delta T$	Gate Source Threshold Voltage Differential Change with Temperature ⁵		100	100/86	$V_{DS} = -15V$, $I_D = -500\mu A$, $T_S = -55^{\circ}C$ to $+25^{\circ}C$
	Differential Change with Temperature	100	μV/°C	$V_{DS} = -15V$, $I_D = -500\mu A$, $T_S = +25^{\circ} C$ to $+125^{\circ} C$	

SWITCHING CHARACTERISTICS

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	CONDITIONS
t _{d(on)}	Turn On Delay Time			15	ns	
t _r	Turn On Rise Time			30		$V_{DD} = -15V$, $I_{D(on)} = -5mA$, $R_G = R_L = 1.4K\Omega$
t _{off}	Turn Off Time			50		

Note 1 - Absolute maximum ratings are limiting values above which LS3N190 serviceability may be impaired.

Note 2 – Per Transistor

Note 3 – Approximately doubles for every 10° C in T_A

Note 4 – Measured at end points, T_A and T_B

Note 5 – Pulse: $t = 300\mu$ S, Duty Cycle $\leq 3\%$

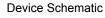


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Email: chipcomponents@micross.com Web: http://www.micross.com/distribution Available Packages:

LS3N190 in TO-72 LS3N190 in bare die.

Please contact Micross for full package and die dimensions



TO-78 (Bottom View)

